

## N- and P-Channel 20V (D-S) Power MOSFET

### FEATURES

- Low  $R_{DS(ON)}$  to minimize conductive losses
- Low gate charge for fast power switching
- Compliant to RoHS directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

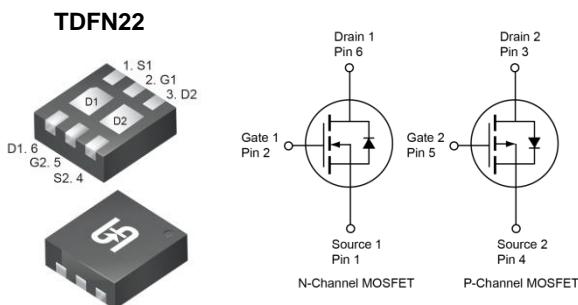
### APPLICATIONS

- Load Switch
- Power Management
- Portable Devices

KEY PERFORMANCE PARAMETERS			
PARAMETER	TYPE	VALUE	UNIT
$V_{DS}$	N-ch	20	V
	P-ch	-20	
$R_{DS(on)}$ (max)	N-ch	30	mΩ
		36	
		42	
	P-ch	55	
		78	
		90	
$Q_g$	N-ch	9.1	nC
	P-ch	9.8	



ROHS COMPLIANT HALOGEN FREE



**Note:** MSL 3 (Moisture Sensitivity Level) per J-STD-020

### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	N-ch	P-ch	UNIT
Drain-Source Voltage	$V_{DS}$	20	-20	V
Gate-Source Voltage	$V_{GS}$	$\pm 12$	$\pm 12$	V
Continuous Drain Current <small>(Note 1)</small>	$I_D$	11.6	-9	A
$T_C = 25^\circ\text{C}$		6.4	-5	
Pulsed Drain Current	$I_{DM}$	46.4	-36	A
Total Power Dissipation	$P_D$	6.25	6.25	W
$T_C = 125^\circ\text{C}$		1.25	1.25	
Total Power Dissipation	$P_D$	1.89	1.89	W
$T_A = 25^\circ\text{C}$		0.38	0.38	
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to +150		°C

### THERMAL PERFORMANCE

PARAMETER	SYMBOL	LIMIT	UNIT
Thermal Resistance – Junction to Case	$R_{\theta JC}$	20	°C/W
Thermal Resistance – Junction to Ambient	$R_{\theta JA}$	66	

**Thermal Performance Note:**  $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistances. The case-thermal reference is defined at the solder mounting surface of the drain pins.  $R_{\theta JA}$  is guaranteed by design while  $R_{\theta CA}$  is determined by the user's board design.

<b>ELECTRICAL SPECIFICATIONS</b> ( $T_A = 25^\circ\text{C}$ unless otherwise noted)							
<b>PARAMETER</b>	<b>CONDITIONS</b>	<b>SYMBOL</b>	<b>TYPE</b>	<b>MIN</b>	<b>TYP</b>	<b>MAX</b>	<b>UNIT</b>
<b>Static</b>							
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu\text{A}$	$BV_{DSS}$	N-ch	20	--	--	V
	$V_{GS} = 0V, I_D = -250\mu\text{A}$		P-ch	-20	--	--	
Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250\mu\text{A}$	$V_{GS(\text{TH})}$	N-ch	0.5	0.8	1	V
	$V_{GS} = V_{DS}, I_D = -250\mu\text{A}$		P-ch	-0.45	-0.7	-1	
Gate-Source Leakage Current	$V_{GS} = \pm 12V, V_{DS} = 0V$	$I_{GSS}$	N-ch	--	--	$\pm 100$	nA
	$V_{GS} = \pm 12V, V_{DS} = 0V$		P-ch	--	--	$\pm 100$	
Drain-Source Leakage Current	$V_{GS} = 0V, V_{DS} = 20V$	$I_{DSS}$	N-ch	--	--	1	$\mu\text{A}$
	$V_{GS} = 0V, V_{DS} = 20V$			--	--	100	
	$T_J = 125^\circ\text{C}$		P-ch	--	--	-1	
	$V_{GS} = 0V, V_{DS} = -20V$			--	--	-100	
	$V_{GS} = 0V, V_{DS} = -20V$			--	--	-100	
Drain-Source On-State Resistance <sup>(Note 2)</sup>	$V_{GS} = 4.5V, I_D = 6.4A$	$R_{DS(\text{on})}$	N-ch	--	17	30	$\text{m}\Omega$
	$V_{GS} = 2.5V, I_D = 5.8A$			--	22	36	
	$V_{GS} = 1.8V, I_D = 5.4A$			--	32	42	
	$V_{GS} = -4.5V, I_D = -5A$		P-ch	--	48	55	
	$V_{GS} = -2.5V, I_D = -4.2A$			--	60	78	
	$V_{GS} = -1.8V, I_D = -3.9A$			--	78	90	
Forward Transconductance <sup>(Note 2)</sup>	$V_{DS} = 5V, I_D = 6.4A$	$g_{fs}$	N-ch	--	28	--	S
	$V_{DS} = -5V, I_D = -5A$		P-ch	--	15	--	
<b>Dynamic</b> <sup>(Note 3)</sup>							
Total Gate Charge	$N\text{-ch}$ $V_{GS} = 4.5V,$ $V_{DS} = 10V, I_D = 6.4A$	$Q_g$	N-ch	--	9.1	--	$\text{nC}$
			P-ch	--	9.8	--	
Gate-Source Charge	$P\text{-ch}$	$Q_{gs}$	N-ch	--	1.3	--	$\text{nC}$
			P-ch	--	1.1	--	
Gate-Drain Charge	$V_{GS} = -4.5V,$ $V_{DS} = -10V, I_D = -5A$	$Q_{gd}$	N-ch	--	2.7	--	$\text{nC}$
			P-ch	--	2.7	--	
Input Capacitance	$N\text{-ch}$ $V_{GS} = 0V, V_{DS} = 10V$ $f = 1.0\text{MHz}$	$C_{iss}$	N-ch	--	677	--	$\text{pF}$
			P-ch	--	744	--	
Output Capacitance	$P\text{-ch}$	$C_{oss}$	N-ch	--	120	--	$\text{pF}$
			P-ch	--	106	--	
Reverse Transfer Capacitance	$V_{GS} = 0V, V_{DS} = -10V$ $f = 1.0\text{MHz}$	$C_{rss}$	N-ch	--	89	--	$\text{pF}$
			P-ch	--	97	--	
Gate Resistance	$f = 1.0\text{MHz}$	$R_g$	N-ch	--	3	--	$\Omega$
			P-ch	--	80	--	

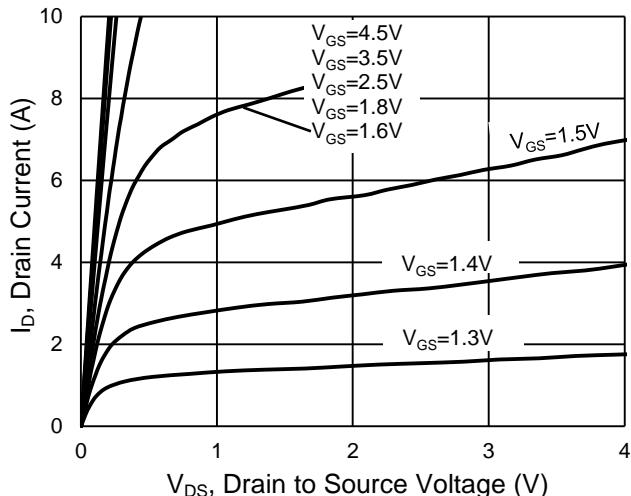
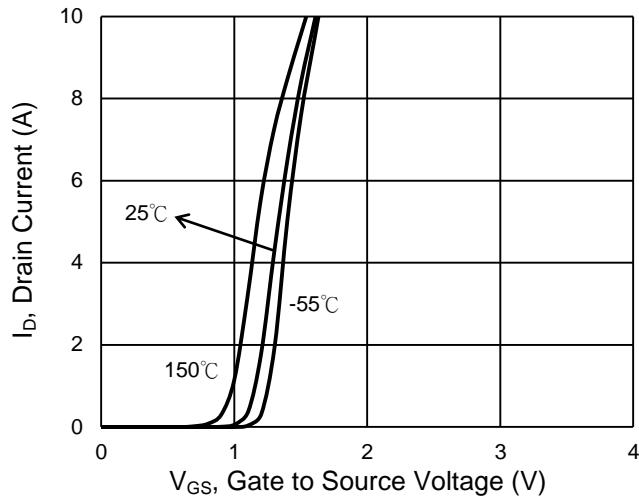
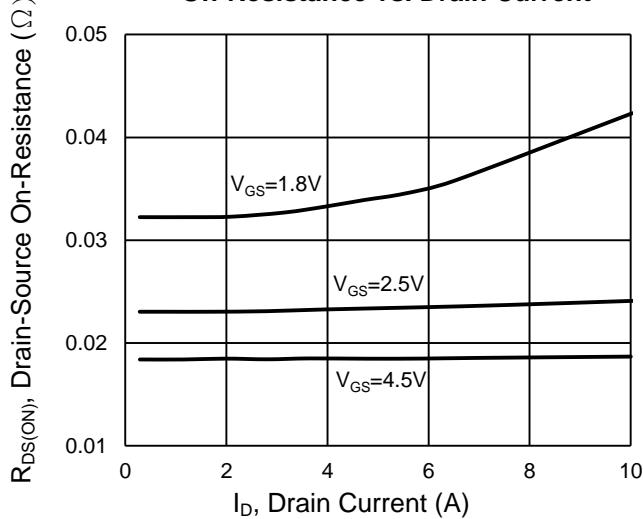
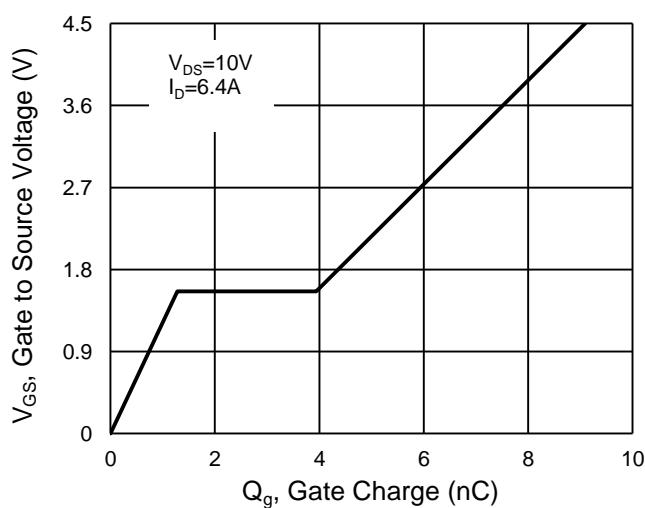
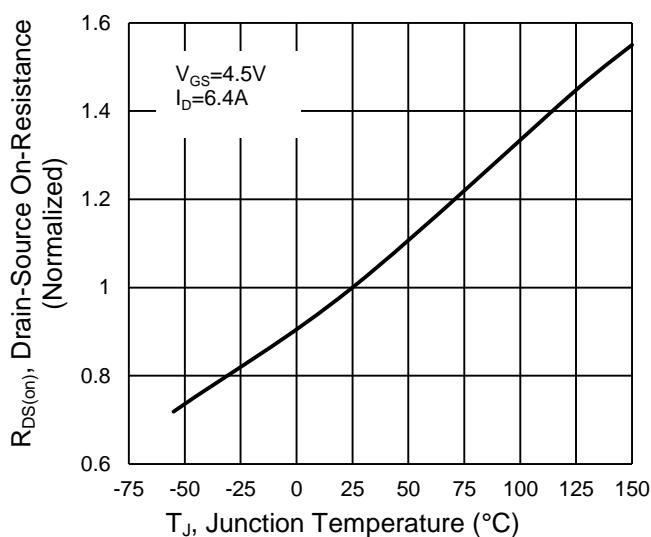
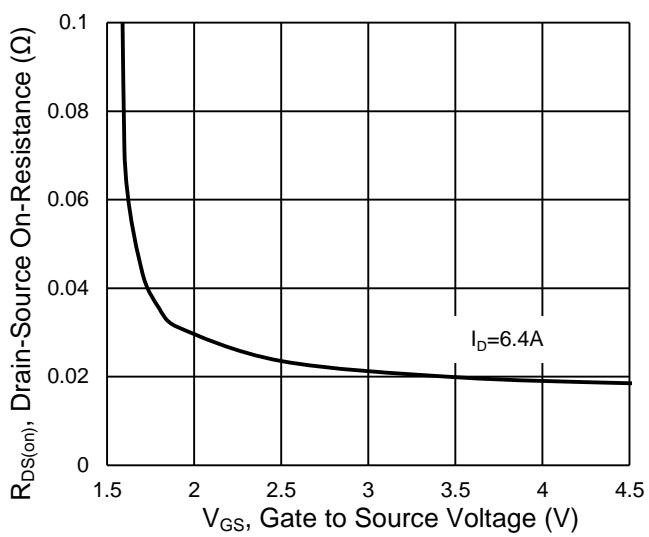
<b>ELECTRICAL SPECIFICATIONS</b> ( $T_A = 25^\circ\text{C}$ unless otherwise noted)							
<b>PARAMETER</b>	<b>CONDITIONS</b>	<b>SYMBOL</b>	<b>TYPE</b>	<b>MIN</b>	<b>TYP</b>	<b>MAX</b>	<b>UNIT</b>
<b>Switching</b> <small>(Note 3)</small>							
Turn-On Delay Time  Turn-On Rise Time  Turn-Off Delay Time  Turn-Off Fall Time	N-ch  $V_{GS} = 4.5V, R_G = 2\Omega$ $V_{DS} = 10V, I_D = 6.4A$	$t_{d(on)}$	N-ch	--	8	--	ns
			P-ch	--	10	--	
	P-ch  $V_{GS} = -4.5V, R_G = 2\Omega$ $V_{DS} = -10V, I_D = -5A$	$t_r$	N-ch	--	41	--	
			P-ch	--	34	--	
	N-ch  $I_S = 6.4A, dI/dt = 100A/\mu\text{s}$  P-ch $I_S = -5A, dI/dt = 100A/\mu\text{s}$	$t_{d(off)}$	N-ch	--	25	--	
			P-ch	--	69	--	
		$t_f$	N-ch	--	30	--	
			P-ch	--	68	--	
<b>Source-Drain Diode</b>							
Forward Voltage <small>(Note 2)</small>	$V_{GS} = 0V, I_S = 6.4A$	$V_{SD}$	N-ch	--	0.7	--	V
	$V_{GS} = 0V, I_S = -5A$		P-ch	--	-0.8	--	
Reverse recovery Time  Reverse Recovery Charge	N-ch $I_S = 6.4A, dI/dt = 100A/\mu\text{s}$	$t_{rr}$	N-ch	--	22	--	nc
			P-ch	--	113	--	
	P-ch $I_S = -5A, dI/dt = 100A/\mu\text{s}$	$Q_{rr}$	N-ch	--	6	--	nc
			P-ch	--	160	--	

**Notes:**

1. Silicon limited current only.
2. Pulse test: Pulse Width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
3. Switching time is essentially independent of operating temperature.

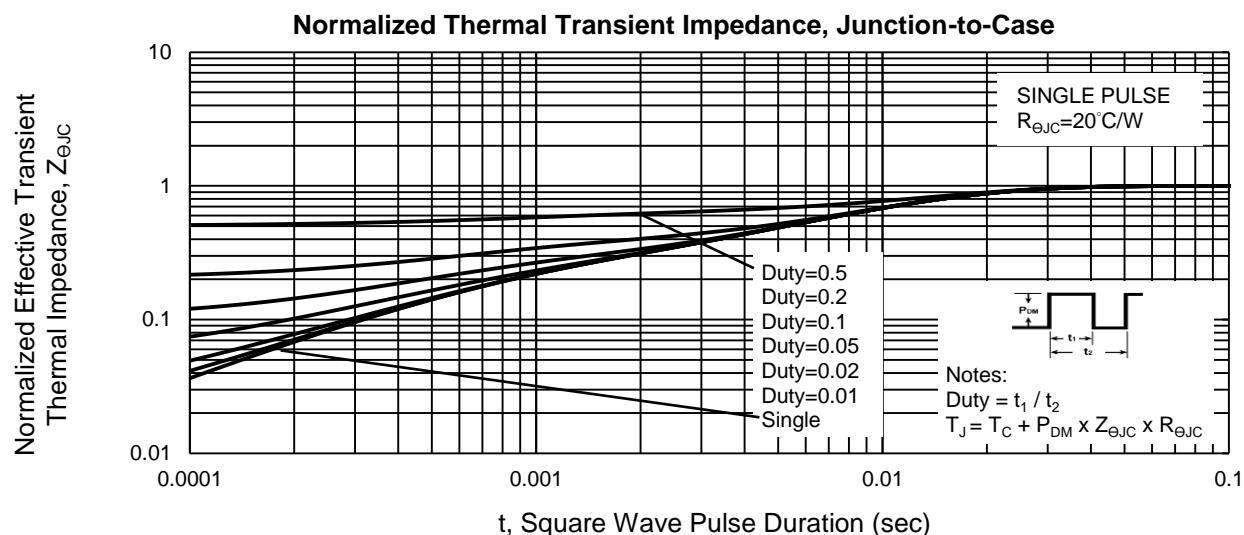
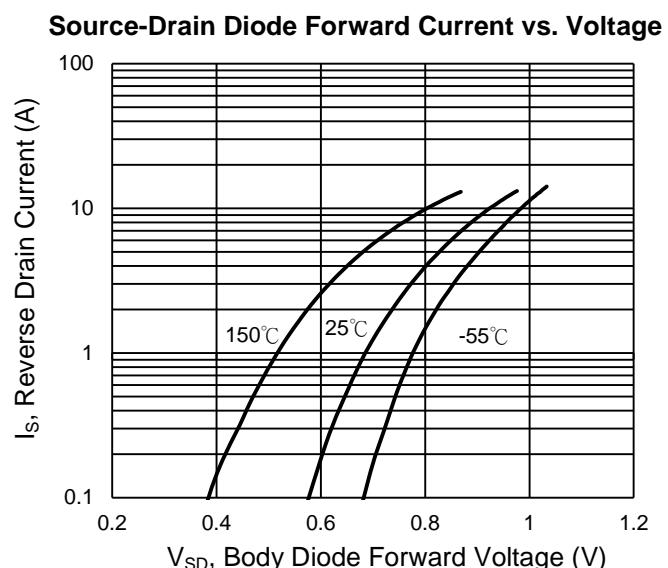
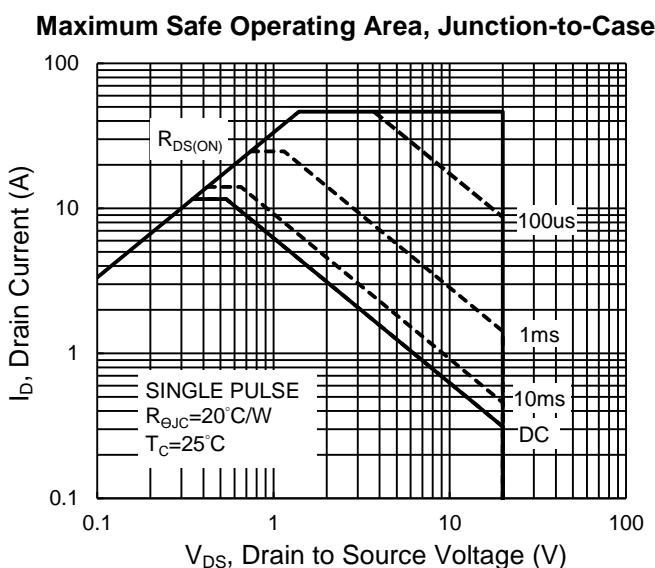
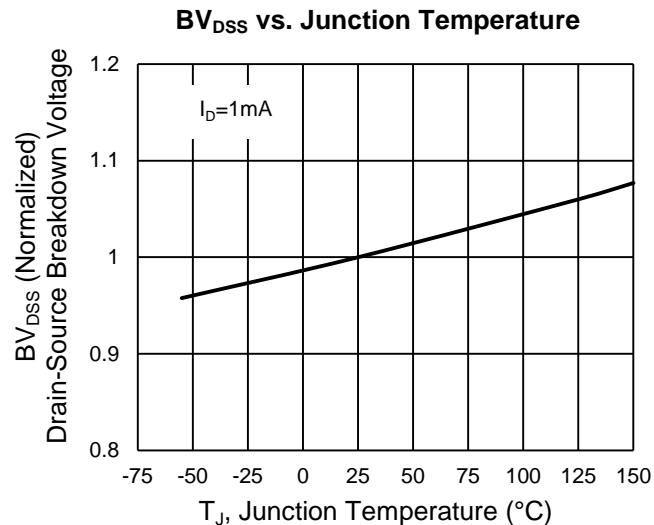
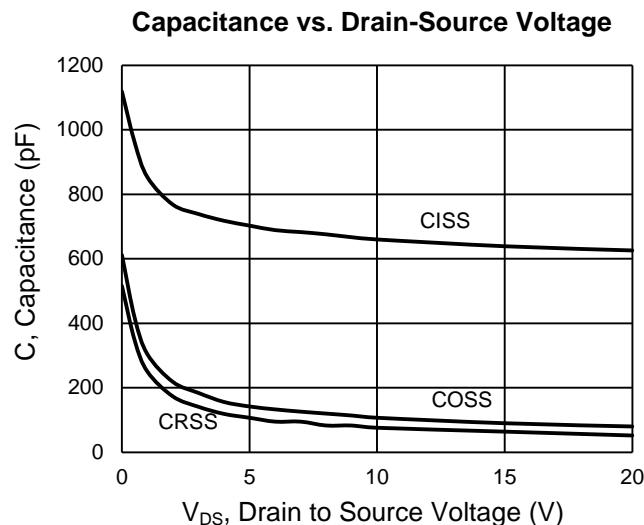
**ORDERING INFORMATION**

<b>PART NO.</b>	<b>PACKAGE</b>	<b>PACKING</b>
TSM2537CQ RFG	TDFN22	3,000pcs / 7" Reel

**CHARACTERISTICS CURVES (N-Channel)**
 $(T_A = 25^\circ\text{C} \text{ unless otherwise noted})$ 
**Output Characteristics**

**Transfer Characteristics**

**On-Resistance vs. Drain Current**

**Gate-Source Voltage vs. Gate Charge**

**On-Resistance vs. Junction Temperature**

**On-Resistance vs. Gate-Source Voltage**


## CHARACTERISTICS CURVES (N-Channel)

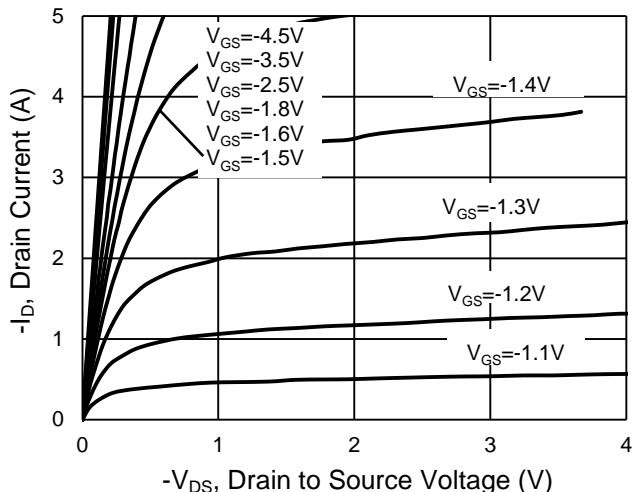
( $T_A = 25^\circ\text{C}$  unless otherwise noted)



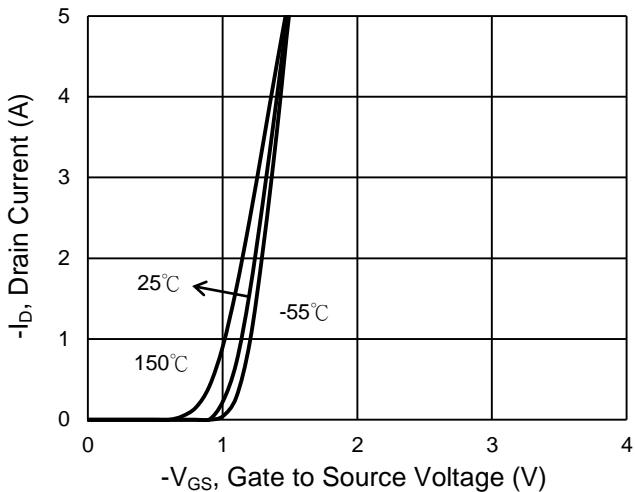
## CHARACTERISTICS CURVES (P-Channel)

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

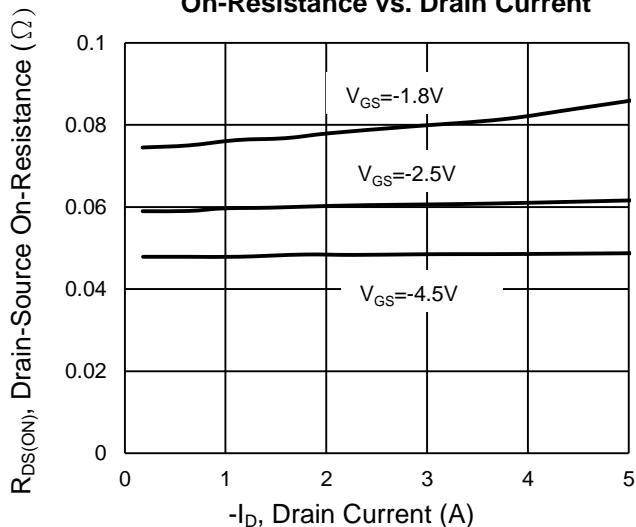
### Output Characteristics



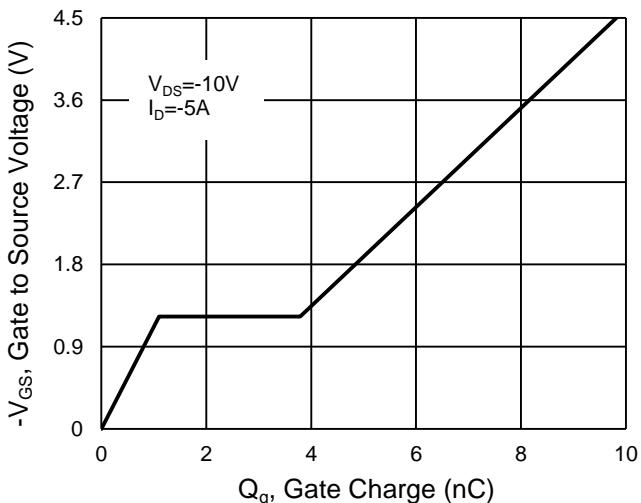
### Transfer Characteristics



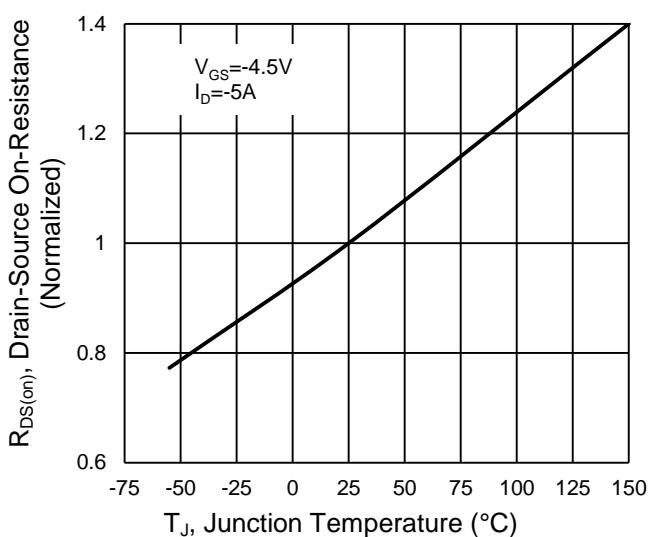
### On-Resistance vs. Drain Current



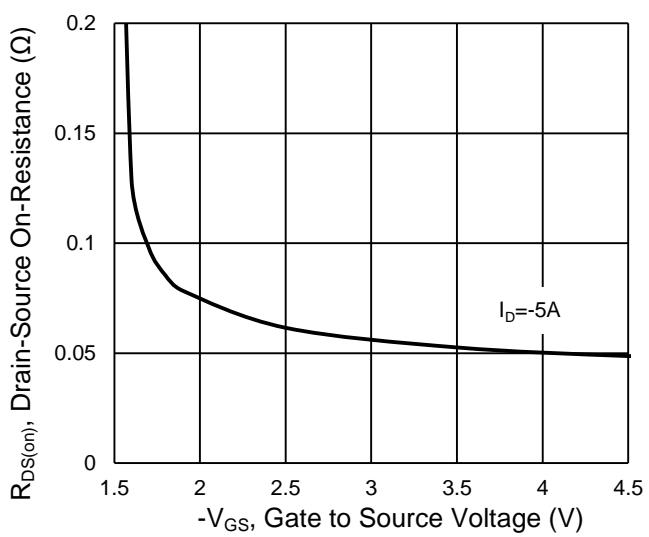
### Gate-Source Voltage vs. Gate Charge



### On-Resistance vs. Junction Temperature

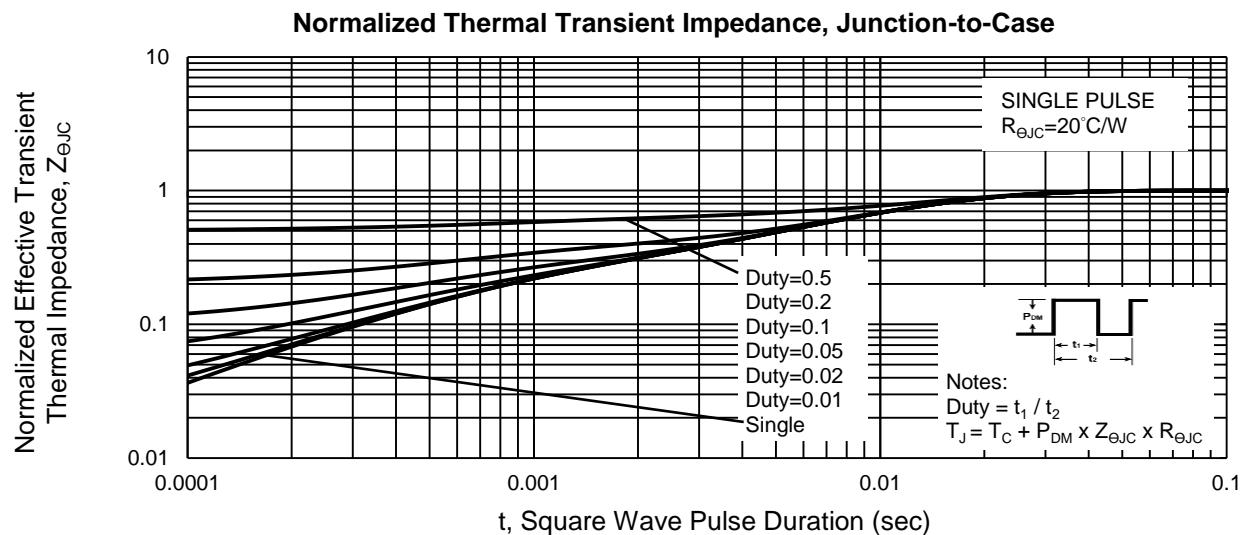
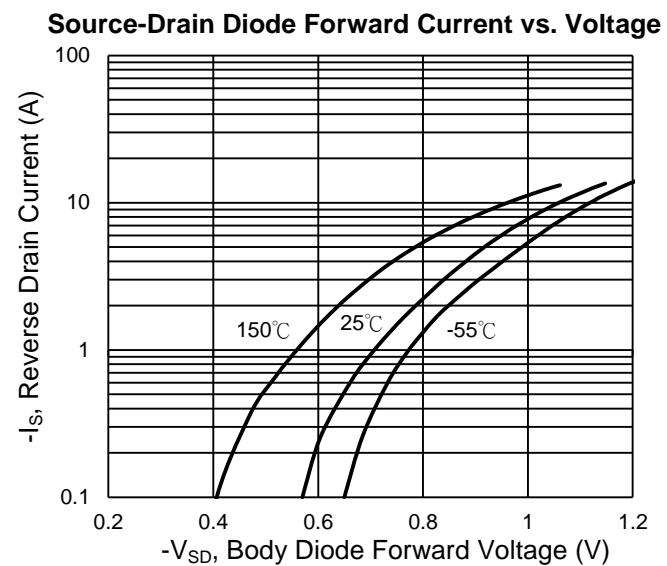
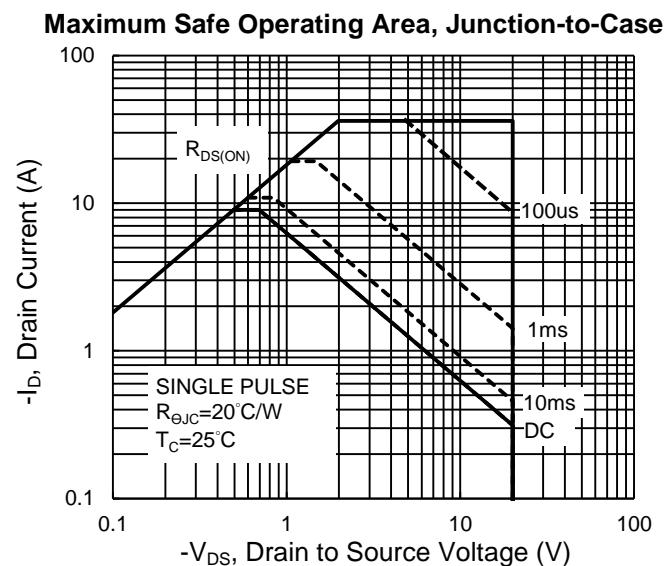
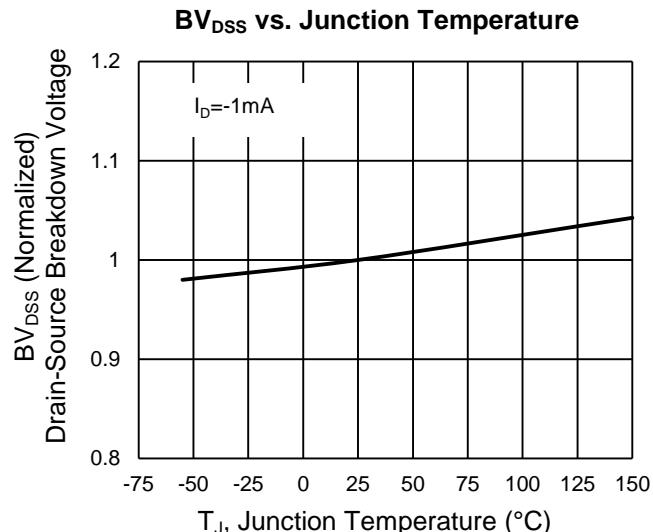
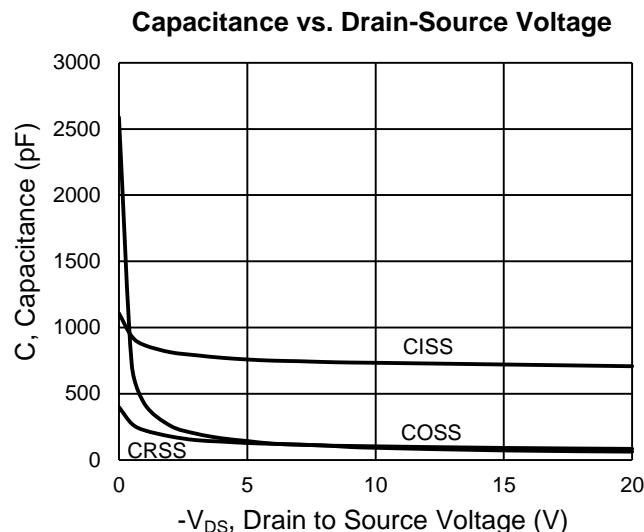


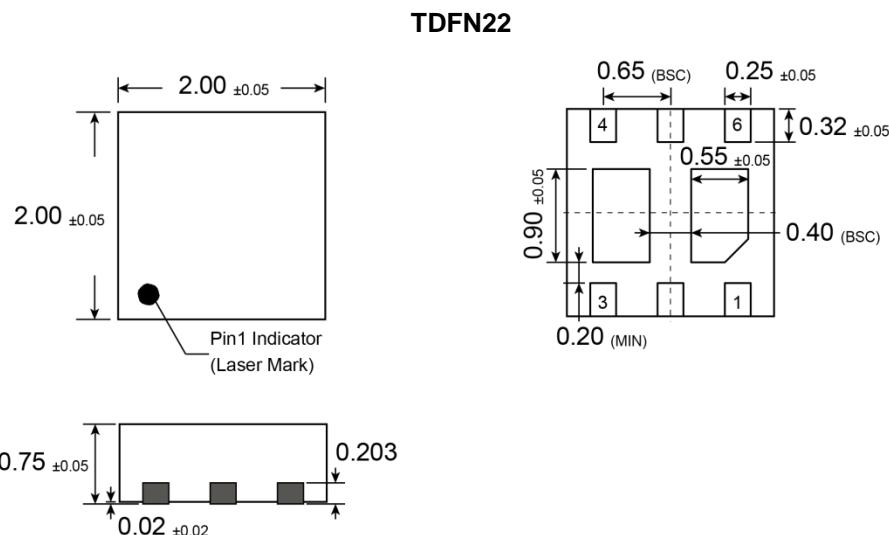
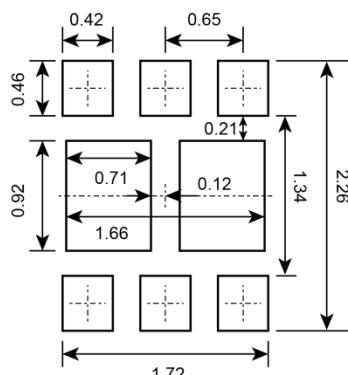
### On-Resistance vs. Gate-Source Voltage



## CHARACTERISTICS CURVES (P-Channel)

( $T_A = 25^\circ\text{C}$  unless otherwise noted)



**PACKAGE OUTLINE DIMENSIONS** (Unit: Millimeters)

**SUGGESTED PAD LAYOUT** (Unit: Millimeters)

**MARKING DIAGRAM**


**Y** = Year Code

**M** = Month Code for Halogen Free

**O** =Jan    **P** =Feb    **Q** =Mar    **R** =Apr

**S** =May    **T** =Jun    **U** =Jul    **V** =Aug

**W** =Sep    **X** =Oct    **Y** =Nov    **Z** =Dec

**L** = Lot Code (1~9, A~Z)

## Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.

ООО "ЛайфЭлектроникс"

"LifeElectronics" LLC

ИНН 7805602321 КПП 780501001 Р/С 40702810122510004610 ФАКБ "АБСОЛЮТ БАНК" (ЗАО) в г.Санкт-Петербурге К/С 30101810900000000703 БИК 044030703

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибуторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибуторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помочь разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный)  
Email: org@lifeelectronics.ru